



Material Content Data Sheet



Halogen-Free

Sales Product Name	IKD03N60RF	Issued	17. February 2022
MA#	MA005619841		
Package	PG-TO252-3-342	Weight*	332.56 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.526	0.16	0.16	1582	1582
leadframe	inorganic material	phosphorus	7723-14-0	0.048	0.01		145	
	non noble metal	iron	7439-89-6	0.160	0.05		482	
	non noble metal	copper	7440-50-8	160.096	48.15	48.21	481399	482026
wire	non noble metal	aluminium	7429-90-5	0.179	0.05	0.05	538	538
encapsulation	organic material	carbon black	1333-86-4	1.179	0.35		3546	
	plastics	epoxy resin	-	16.510	4.96		49644	
	inorganic material	silicondioxide	60676-86-0	129.721	39.01	44.32	390064	443254
leadfinish	non noble metal	tin	7440-31-5	3.740	1.12	1.12	11246	11246
plating	non noble metal	nickel	7440-02-0	0.523	0.16	0.16	1574	1574
solder	non noble metal	tin	7440-31-5	0.014			41	
	noble metal	silver	7440-22-4	0.017	0.01		51	
	non noble metal	lead	7439-92-1	0.648	0.19	0.20	1948	2040
heatspreader	inorganic material	phosphorus	7723-14-0	0.006			17	
	non noble metal	iron	7439-89-6	0.019	0.01		58	
	non noble metal	copper	7440-50-8	19.177	5.77	5.78	57665	57740
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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